

## Insulated Gate Bipolar Transistor (Trench IGBT), 80 A



SOT-227

### PRIMARY CHARACTERISTICS

|                                     |                             |
|-------------------------------------|-----------------------------|
| $V_{CES}$                           | 1200 V                      |
| $I_C$ DC                            | 80 A at 104 °C              |
| $V_{CE(on)}$ typical at 80 A, 25 °C | 2.0 V                       |
| Speed                               | 8 kHz to 30 kHz             |
| Package                             | SOT-227                     |
| Circuit configuration               | Single switch with AP diode |

### FEATURES

- Trench IGBT technology
- Positive  $V_{CE(on)}$  temperature coefficient
- Square RBSOA
- 10  $\mu$ s short circuit capability
- HEXFRED® low  $Q_{rr}$ , low switching energy
- $T_J$  maximum = 150 °C
- Fully isolated package
- Very low internal inductance ( $\leq 5$  nH typical)
- Industry standard outline
- UL approved file E78996 
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT

### BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- Direct mounting to heatsink
- Plug-in compatible with other SOT-227 packages
- Low EMI, requires less snubbing

### ABSOLUTE MAXIMUM RATINGS

| PARAMETER                        | SYMBOL     | TEST CONDITIONS                                            | MAX.     | UNITS |
|----------------------------------|------------|------------------------------------------------------------|----------|-------|
| Collector to emitter voltage     | $V_{CES}$  |                                                            | 1200     | V     |
| Continuous collector current     | $I_C$      | $T_C = 25\text{ °C}$                                       | 139      | A     |
|                                  |            | $T_C = 90\text{ °C}$                                       | 93       |       |
| Pulsed collector current         | $I_{CM}$   |                                                            | 170      |       |
| Clamped inductive load current   | $I_{LM}$   |                                                            | 250      |       |
| Diode continuous forward current | $I_F$      | $T_C = 25\text{ °C}$                                       | 98       |       |
|                                  |            | $T_C = 90\text{ °C}$                                       | 61       |       |
| Single pulse forward current     | $I_{FSM}$  | 10 ms sine or 6 ms rectangular pulse, $T_J = 25\text{ °C}$ | 350      |       |
| Gate to emitter voltage          | $V_{GE}$   |                                                            | $\pm 20$ | V     |
| Power dissipation, IGBT          | $P_D$      | $T_C = 25\text{ °C}$                                       | 658      | W     |
|                                  |            | $T_C = 90\text{ °C}$                                       | 316      |       |
| Power dissipation, diode         | $P_D$      | $T_C = 25\text{ °C}$                                       | 403      |       |
|                                  |            | $T_C = 90\text{ °C}$                                       | 194      |       |
| Isolation voltage                | $V_{ISOL}$ | Any terminal to case, $t = 1$ min                          | 2500     | V     |

**ELECTRICAL SPECIFICATIONS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

| PARAMETER                                    | SYMBOL                         | TEST CONDITIONS                                                                                             | MIN. | TYP. | MAX.      | UNITS                  |
|----------------------------------------------|--------------------------------|-------------------------------------------------------------------------------------------------------------|------|------|-----------|------------------------|
| Collector to emitter breakdown voltage       | $V_{BR(CE)}$                   | $V_{GE} = 0\text{ V}$ , $I_C = 2.6\text{ mA}$                                                               | 1200 | -    | -         |                        |
| Collector to emitter voltage                 | $V_{CE(on)}$                   | $V_{GE} = 15\text{ V}$ , $I_C = 80\text{ A}$                                                                | -    | 2.0  | 2.55      | V                      |
|                                              |                                | $V_{GE} = 15\text{ V}$ , $I_C = 80\text{ A}$ , $T_J = 125\text{ }^{\circ}\text{C}$                          | -    | 2.4  | -         |                        |
|                                              |                                | $V_{GE} = 15\text{ V}$ , $I_C = 80\text{ A}$ , $T_J = 150\text{ }^{\circ}\text{C}$                          | -    | 2.5  | -         |                        |
| Gate threshold voltage                       | $V_{GE(th)}$                   | $V_{CE} = V_{GE}$ , $I_C = 2.6\text{ mA}$                                                                   | 4.75 | 5.7  | 7.0       |                        |
| Temperature coefficient of threshold voltage | $\Delta V_{GE(th)}/\Delta T_J$ | $V_{CE} = V_{GE}$ , $I_C = 2.6\text{ mA}$ ( $25\text{ }^{\circ}\text{C}$ to $125\text{ }^{\circ}\text{C}$ ) | -    | -12  | -         | mV/ $^{\circ}\text{C}$ |
| Collector to emitter leakage current         | $I_{CES}$                      | $V_{GE} = 0\text{ V}$ , $V_{CE} = 1200\text{ V}$                                                            | -    | 1.0  | 100       | $\mu\text{A}$          |
|                                              |                                | $V_{GE} = 0\text{ V}$ , $V_{CE} = 1200\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$                      | -    | 0.9  | -         | mA                     |
| Forward voltage drop                         | $V_{FM}$                       | $I_F = 80\text{ A}$ , $V_{GE} = 0\text{ V}$                                                                 | -    | 2.9  | 3.5       | V                      |
|                                              |                                | $I_F = 80\text{ A}$ , $V_{GE} = 0\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$                           | -    | 3.1  | -         |                        |
|                                              |                                | $I_F = 80\text{ A}$ , $V_{GE} = 0\text{ V}$ , $T_J = 150\text{ }^{\circ}\text{C}$                           | -    | 3.1  | -         |                        |
| Gate to emitter leakage current              | $I_{GES}$                      | $V_{GE} = \pm 20\text{ V}$                                                                                  | -    | -    | $\pm 220$ | nA                     |

**SWITCHING CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

| PARAMETER                         | SYMBOL       | TEST CONDITIONS                                                                                                                                                                                                     | MIN.       | TYP. | MAX. | UNITS         |
|-----------------------------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|------|------|---------------|
| Total gate charge (turn-on)       | $Q_g$        | $V_{GE} = -15\text{ V}$ , $V_{GE} = \pm 15\text{ V}$                                                                                                                                                                | -          | 570  | -    |               |
| Input capacitance                 | $C_{ies}$    | $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$ , $f = 1\text{ MHz}$                                                                                                                                                 | -          | 4400 | -    | pF            |
| Reverse transfer capacitance      | $C_{res}$    |                                                                                                                                                                                                                     | -          | 235  | -    |               |
| Turn-on switching loss            | $E_{on}$     | $I_C = 80\text{ A}$ , $V_{CC} = 600\text{ V}$ , $V_{GE} = 15\text{ V}$ ,<br>$R_g = 1.0\text{ }\Omega$ , $L = 500\text{ }\mu\text{H}$ ,<br>$T_J = 25\text{ }^{\circ}\text{C}$                                        | -          | 3.0  | -    | mJ            |
| Turn-off switching loss           | $E_{off}$    |                                                                                                                                                                                                                     | -          | 3.2  | -    |               |
| Total switching loss              | $E_{tot}$    |                                                                                                                                                                                                                     | -          | 6.2  | -    |               |
| Turn-on switching loss            | $E_{on}$     | $I_C = 80\text{ A}$ , $V_{CC} = 600\text{ V}$ , $V_{GE} = 15\text{ V}$ ,<br>$R_g = 1.0\text{ }\Omega$ , $L = 500\text{ }\mu\text{H}$ , $T_J = 125\text{ }^{\circ}\text{C}$                                          | -          | 3.9  | -    | mJ            |
| Turn-off switching loss           | $E_{off}$    |                                                                                                                                                                                                                     | -          | 5.5  | -    |               |
| Total switching loss              | $E_{tot}$    |                                                                                                                                                                                                                     | -          | 9.4  | -    |               |
| Turn-on delay time                | $t_{d(on)}$  |                                                                                                                                                                                                                     | -          | 134  | -    | ns            |
| Rise time                         | $t_r$        |                                                                                                                                                                                                                     | -          | 65   | -    |               |
| Turn-off delay time               | $t_{d(off)}$ |                                                                                                                                                                                                                     | -          | 281  | -    |               |
| Fall time                         | $t_f$        |                                                                                                                                                                                                                     | -          | 155  | -    |               |
| Reverse bias safe operating area  | RBSOA        | $T_J = 150\text{ }^{\circ}\text{C}$ , $I_C = 250\text{ A}$ , $R_g = 1.0\text{ }\Omega$ , $V_{GE} = 15\text{ V}$ to $0\text{ V}$ ,<br>$V_{CC} = 800\text{ V}$ , $V_P = 1200\text{ V}$ , $L = 500\text{ }\mu\text{H}$ | Fullsquare |      |      |               |
| Diode reverse recovery time       | $t_{rr}$     | $I_F = 50\text{ A}$ , $di_F/dt = 200\text{ A}/\mu\text{s}$ , $V_R = 400\text{ V}$                                                                                                                                   | -          | 179  | -    | ns            |
| Diode peak reverse current        | $I_{rr}$     |                                                                                                                                                                                                                     | -          | 11.5 | -    | A             |
| Diode recovery charge             | $Q_{rr}$     |                                                                                                                                                                                                                     | -          | 1029 | -    | nC            |
| Diode reverse recovery time       | $t_{rr}$     | $I_F = 50\text{ A}$ , $di_F/dt = 200\text{ A}/\mu\text{s}$ ,<br>$V_{rr} = 400\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$                                                                                       | -          | 275  | -    | ns            |
| Diode peak reverse current        | $I_{rr}$     |                                                                                                                                                                                                                     | -          | 17.8 | -    | A             |
| Diode recovery charge             | $Q_{rr}$     |                                                                                                                                                                                                                     | -          | 2451 | -    | nC            |
| Short circuit safe operating area | SCSOA        | $V_{GE} = 15\text{ V}$ , $V_{CC} = 800\text{ V}$ , $V_{CE\text{ max.}} = 1200\text{ V}$ , $T_J = 150\text{ }^{\circ}\text{C}$                                                                                       | 10         |      |      | $\mu\text{s}$ |

**THERMAL AND MECHANICAL SPECIFICATIONS**

| PARAMETER                              | SYMBOL            | TEST CONDITIONS       | MIN. | TYP. | MAX.       | UNITS                       |
|----------------------------------------|-------------------|-----------------------|------|------|------------|-----------------------------|
| Junction and storage temperature range | $T_J$ , $T_{Stg}$ |                       | -40  | -    | 150        | $^{\circ}\text{C}$          |
| Junction to case                       | IGBT              | $R_{thJC}$            | -    | -    | 0.19       | $^{\circ}\text{C}/\text{W}$ |
|                                        | Diode             |                       | -    | -    | 0.31       |                             |
| Case to heatsink                       | $R_{thCS}$        | Flat, greased surface | -    | 0.1  | -          |                             |
| Weight                                 |                   |                       | -    | 30   | -          | g                           |
| Mounting torque                        |                   | Torque to terminal    | -    | -    | 1.1 (9.7)  | Nm (lbf. in)                |
|                                        |                   | Torque to heatsink    | -    | -    | 1.3 (11.5) | Nm (lbf. in)                |
| Case style                             |                   | SOT-227               |      |      |            |                             |

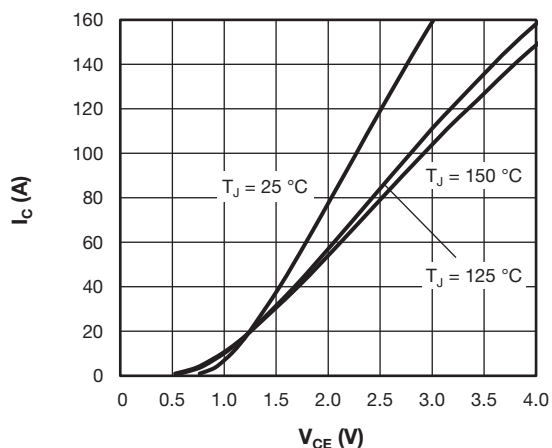
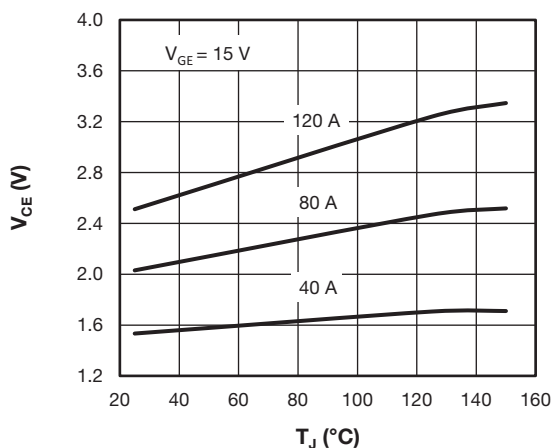

Fig. 1 - Typical IGBT Output Characteristics,  $V_{GE} = 15\text{ V}$ 


Fig. 4 - Collector to Emitter Voltage vs. Junction Temperature

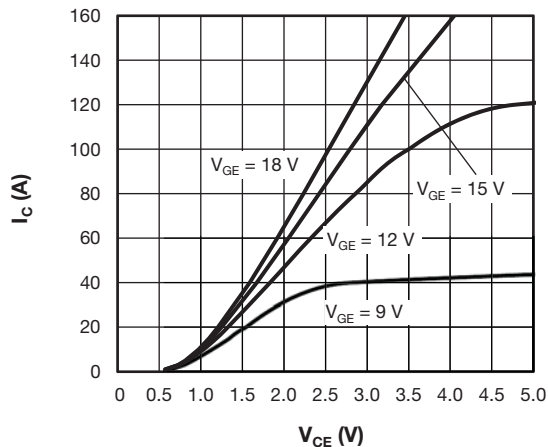
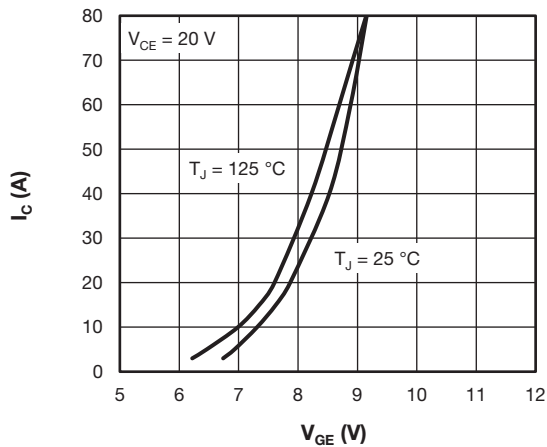

Fig. 2 - Typical IGBT Output Characteristics,  $T_J = 125\text{ °C}$ 


Fig. 5 - Typical IGBT Transfer Characteristics

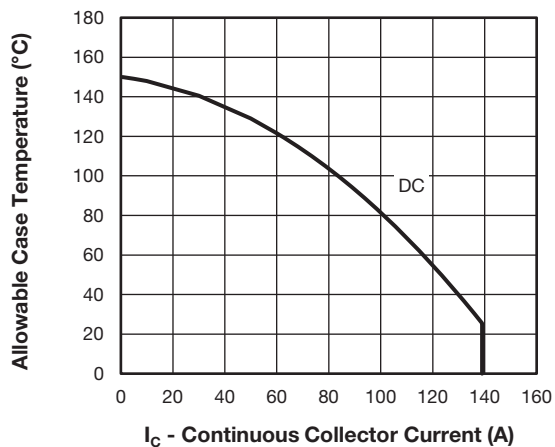


Fig. 3 - Maximum IGBT Continuous Collector Current vs. Case Temperature

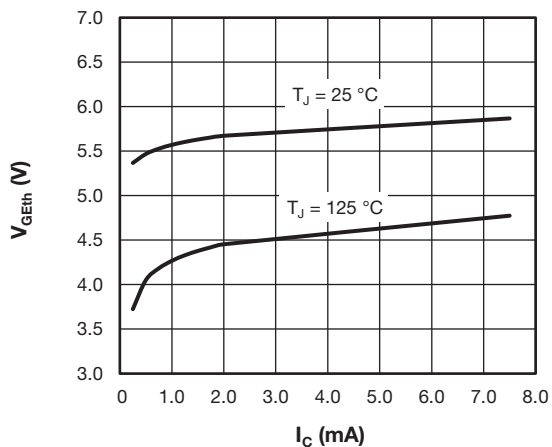


Fig. 6 - Typical IGBT Gate Threshold Voltage

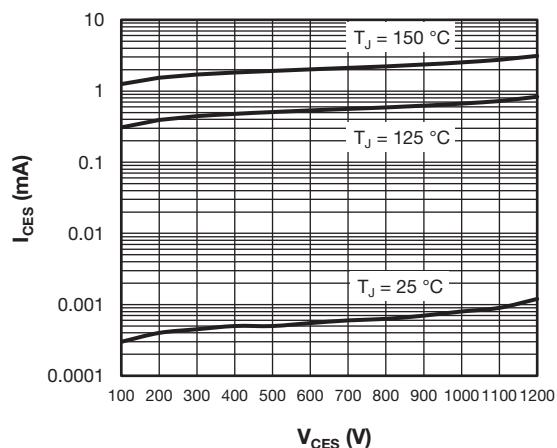


Fig. 7 - Typical IGBT Zero Gate Voltage Collector Current

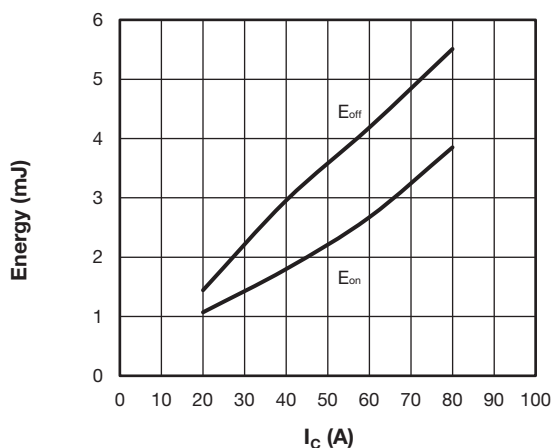
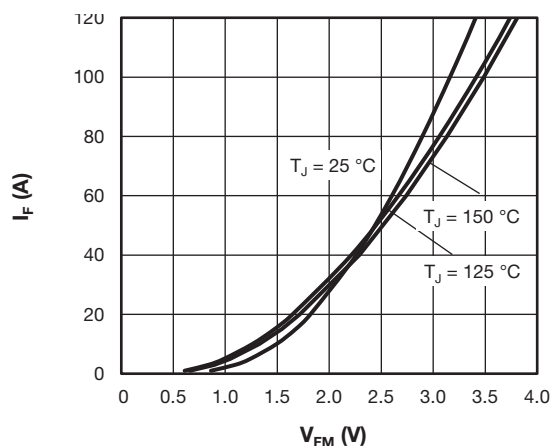

Fig. 10 - Typical IGBT Energy Loss vs  $I_C$   
 $T_J = 125\text{ °C}$ ,  $V_{CC} = 600\text{ V}$ ,  $R_g = 1.0\text{ }\Omega$ ,  $V_{GE} = 15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$ 


Fig. 8 - Typical Diode Forward Characteristics

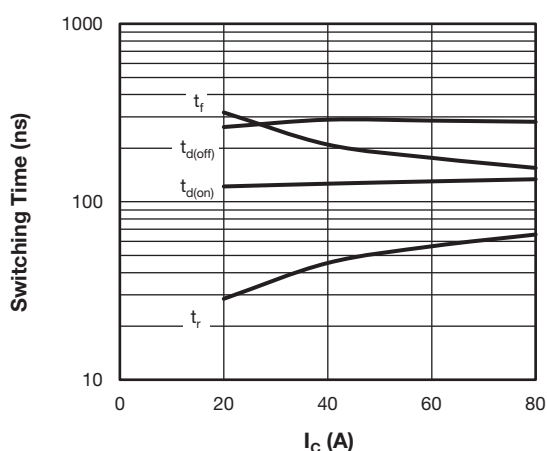
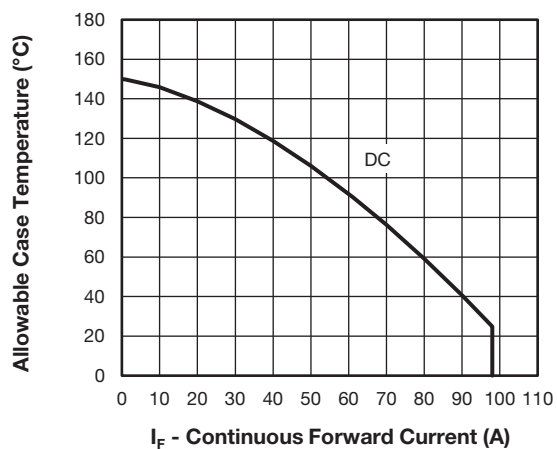
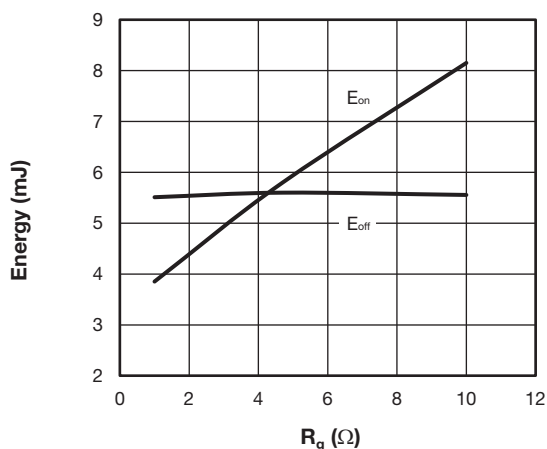

Fig. 11 - Typical IGBT Switching Time vs.  $I_C$   
 $T_J = 125\text{ °C}$ ,  $V_{CC} = 600\text{ V}$ ,  $R_g = 1.0\text{ }\Omega$ ,  $V_{GE} = 15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$ 


Fig. 9 - Maximum Diode Continuous Forward Current vs. Case Temperature


Fig. 12 - Typical IGBT Energy Loss vs.  $R_g$   
 $T_J = 125\text{ °C}$ ,  $V_{CC} = 600\text{ V}$ ,  $I_C = 80\text{ A}$ ,  $V_{GE} = 15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$

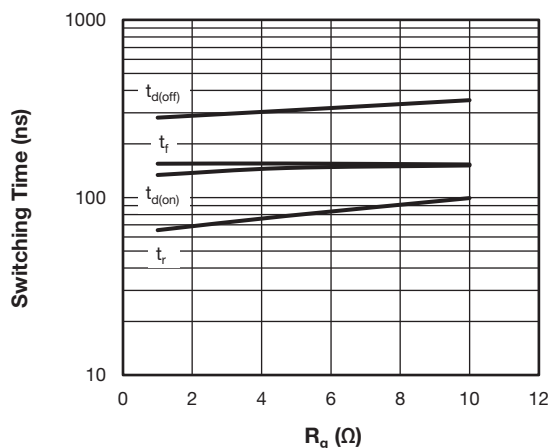


Fig. 13 - Typical IGBT Switching Time vs.  $R_g$   
 $T_J = 125^\circ\text{C}$ ,  $V_{CC} = 600\text{ V}$ ,  $I_C = 80\text{ A}$ ,  $V_{GE} = 15\text{ V}$ ,  $L = 500\text{ }\mu\text{H}$

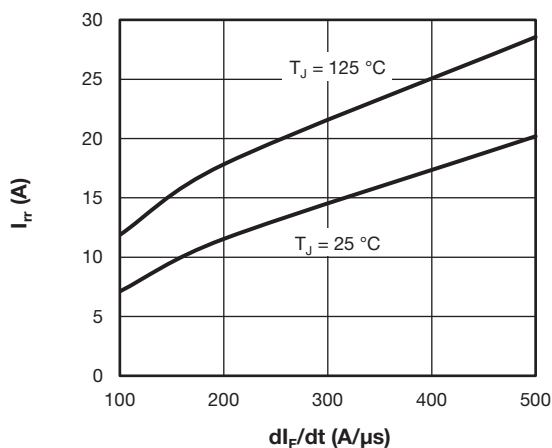


Fig. 15 - Typical Diode Reverse Recovery Current vs.  $di_F/dt$   
 $V_{rr} = 400\text{ V}$ ,  $I_F = 50\text{ A}$

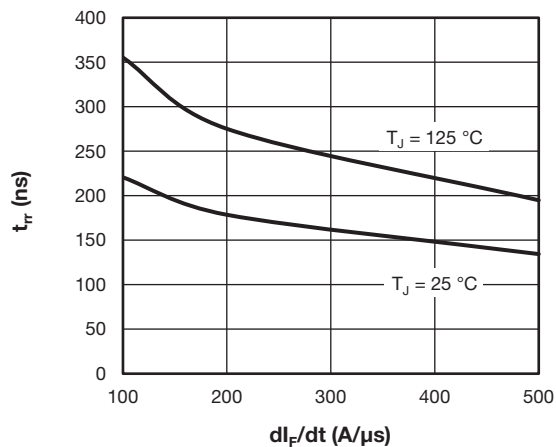


Fig. 14 - Typical Diode Reverse Recovery Time vs.  $di_F/dt$   
 $V_{rr} = 400\text{ V}$ ,  $I_F = 50\text{ A}$

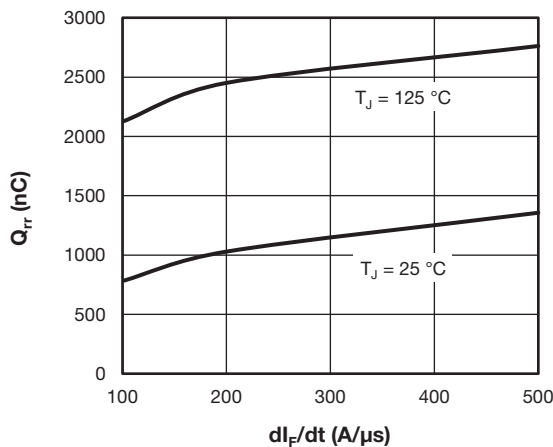


Fig. 16 - Typical Diode Reverse Recovery Charge vs.  $di_F/dt$   
 $V_{rr} = 400\text{ V}$ ,  $I_F = 50\text{ A}$

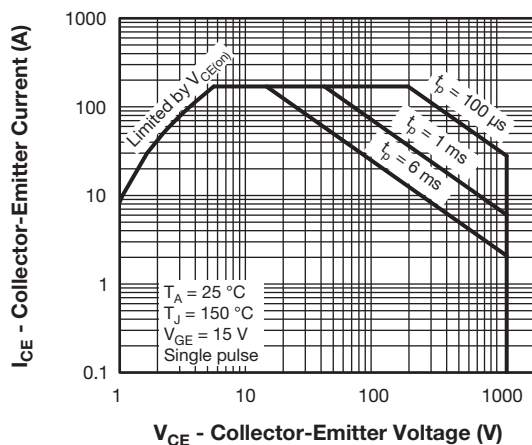


Fig. 17 - IGBT Safe Operating Area

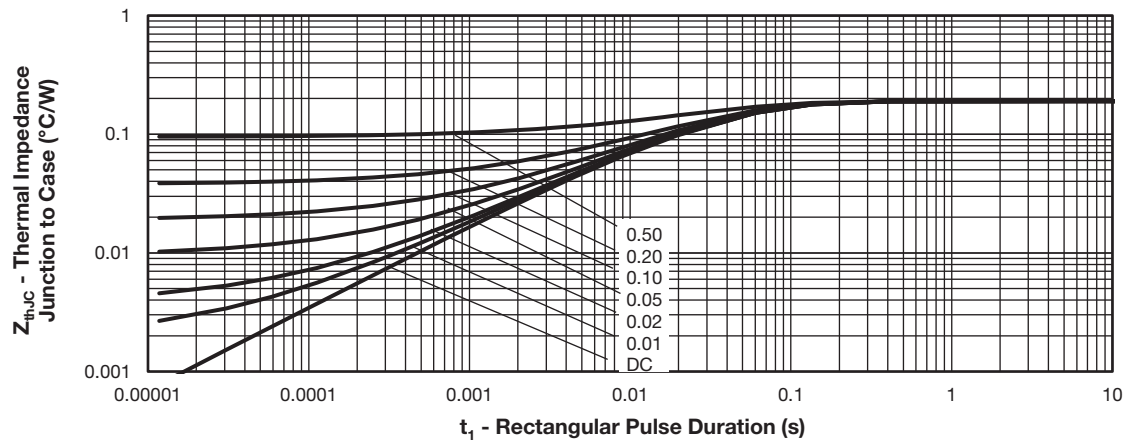


Fig. 18 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (IGBT)

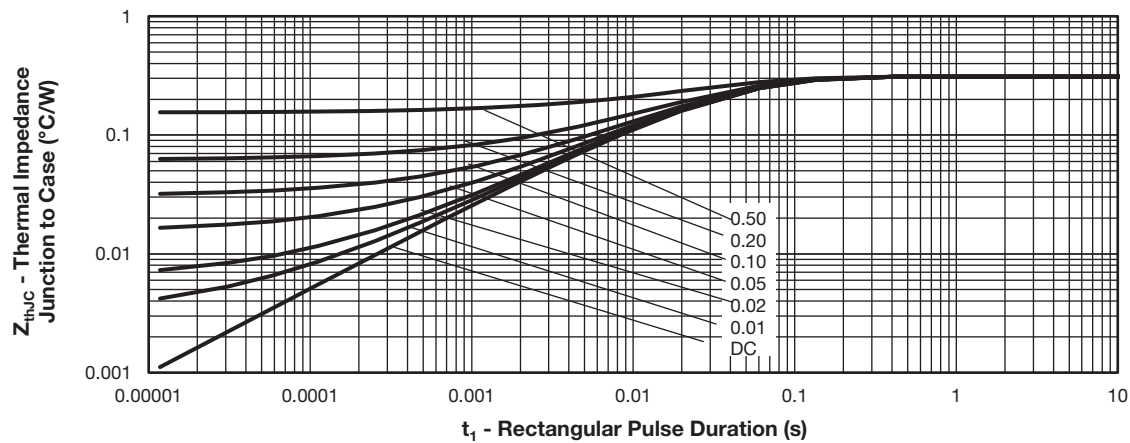


Fig. 19 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Diode)

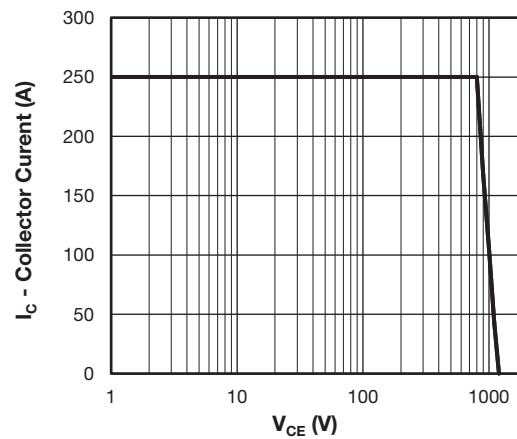
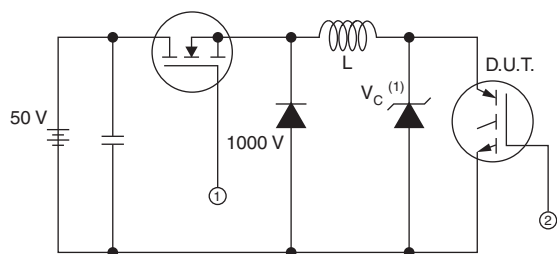


Fig. 20 - IGBT Reverse Bias SOA  
 $V_{GE} = 15\text{ V}$ ,  $T_J = 150\text{ }^{\circ}\text{C}$



**Note:**

<sup>(1)</sup> Driver same type as D.U.T.;  $V_C = 80\%$  of  $V_{CE\text{ max}}$ .  
Due to the 50 V power supply, pulse width, and inductor will increase to obtain  $I_D$

Fig. 21 - Clamped Inductive Load Test Circuit

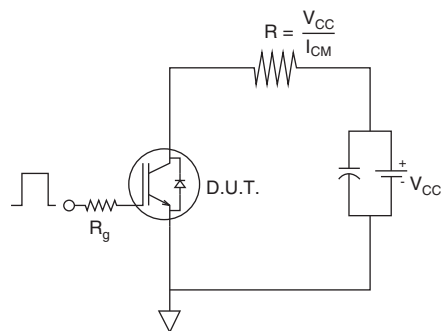


Fig. 22 - Pulsed Collector Current Test Circuit

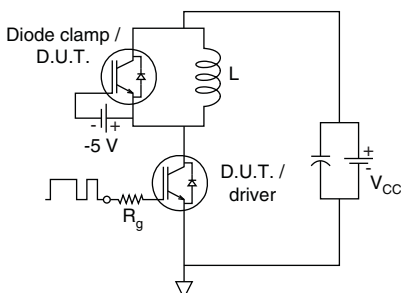


Fig. 23 - Switching Loss Test Circuit

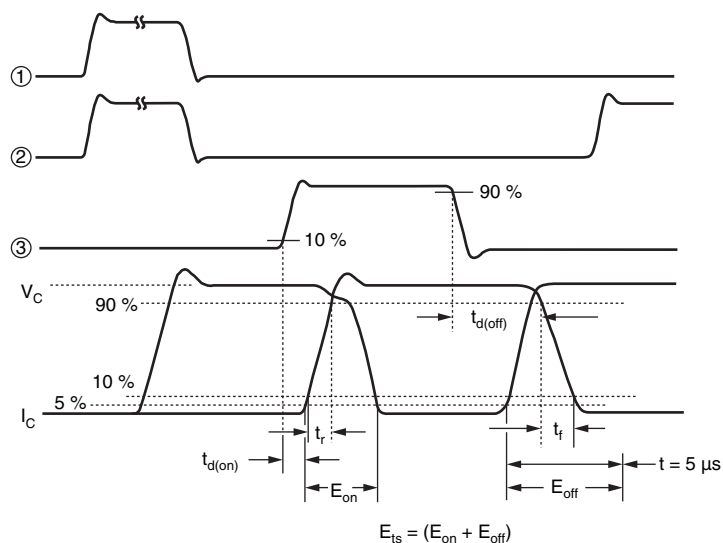
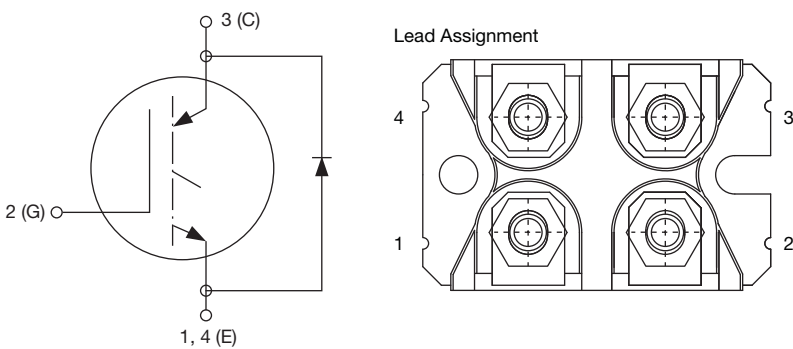


Fig. 24 - Switching Loss Waveforms Test Circuit

**ORDERING INFORMATION TABLE**

|             |            |          |          |           |          |          |            |          |
|-------------|------------|----------|----------|-----------|----------|----------|------------|----------|
| Device code | <b>VS-</b> | <b>G</b> | <b>T</b> | <b>80</b> | <b>D</b> | <b>A</b> | <b>120</b> | <b>U</b> |
|             | 1          | 2        | 3        | 4         | 5        | 6        | 7          | 8        |

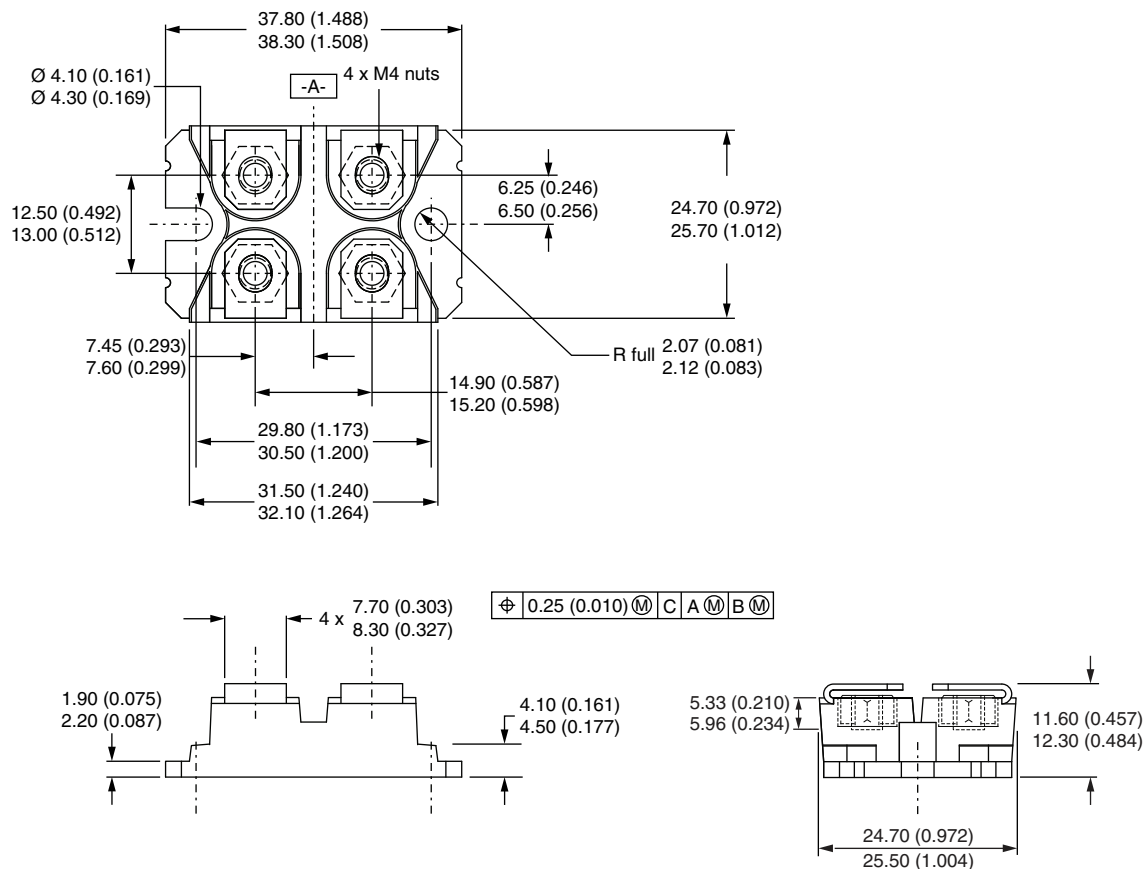
- |          |   |                                                                   |
|----------|---|-------------------------------------------------------------------|
| <b>1</b> | - | Vishay Semiconductors product                                     |
| <b>2</b> | - | Insulated gate bipolar transistor (IGBT)                          |
| <b>3</b> | - | Trench IGBT technology                                            |
| <b>4</b> | - | Current rating (80 = 80 A)                                        |
| <b>5</b> | - | Circuit configuration (D = single switch with antiparallel diode) |
| <b>6</b> | - | Package indicator (A = SOT-227)                                   |
| <b>7</b> | - | Voltage rating (120 = 1200 V)                                     |
| <b>8</b> | - | Speed / type (U = ultrafast)                                      |

| CIRCUIT CONFIGURATION       |                            |                                                                                     |
|-----------------------------|----------------------------|-------------------------------------------------------------------------------------|
| CIRCUIT                     | CIRCUIT CONFIGURATION CODE | CIRCUIT DRAWING                                                                     |
| Single switch with AP diode | D                          |  |

| LINKS TO RELATED DOCUMENTS |                                                                        |
|----------------------------|------------------------------------------------------------------------|
| Dimensions                 | <a href="http://www.vishay.com/doc?95423">www.vishay.com/doc?95423</a> |
| Packaging information      | <a href="http://www.vishay.com/doc?95425">www.vishay.com/doc?95425</a> |

## SOT-227 Generation 2

**DIMENSIONS** in millimeters (inches)



### Note

- Controlling dimension: millimeter



## Disclaimer

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